

RoHS Compliance.

In order to comply with the RoHS 2011/65/EU directive amended by (EU)2015/863, CCEE regularly evaluates the materials used in our printed circuit board manufacturing process. The last evaluation has taken place during July 2019 to consider the four additional substances added under RoHS 3. We have been able to obtain written confirmation of conformity from all our suppliers; whose materials are present in our final product that these materials are within the specified boundaries of the RoHS requirements.

Accordingly, CCEE can confirm that all our product manufactured on FR4 material is compliant with the RoHS directive.

An exception to the above statement is product manufactured using tin lead hot air solder level.

We currently offer the following RoHS compliant solderable finishes

- lead-free hot air solder level
- electroless nickel immersion gold
- immersion tin
- silver
- OSP
- electroplated (hard) gold.

There are many base laminate materials that can be used to manufacture printed circuit boards and we cannot confirm that all of the base materials available are RoHS compliant. RoHS compliancy is however indicated on the C of C.

If our customers wish us to manufacture on non-standard materials, we will be able to confirm RoHS compliance by contacting the material supplier as required.



Dave Hotston
Technical Manager